

AMENDMENT

UNDER ARTICLE 34(2)(B)PCT

To: The Examiner of Patent Office Mr. Shogo OHSIMA

1 Identification of the International Application: PCT/JP2004/013637

2 Applicant (Common Representative):

Name: NIPPON CARBIDE KOGYO KABUSHIKI KAISHA

Address: 11-19, Kohnan 2-chome, Minato-ku, TOKYO
108-8466 JAPAN

Country of nationality: JAPAN

Country of residence: JAPAN

3 Agent:

Name: (7653) Patent Attorney HATORI Osamu

Address: AKASAKA HKN BLDG. 6F, 8-6, Akasaka 1-chome,
Minato-ku, TOKYO 107-0052 JAPAN

4 Items to be Amended:

Claims

5 Subject Matter of Amendment:

As per attached sheets

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[Amended Items]

(1) The phrases of “at least one of the mold cleaning materials” and “the at least two mold cleaning materials” recited in claim 6 are redrafted as -- at least one of the base sheets -- and -- the at least two base sheets --, respectively.

(2) The phrase of “at least two mold cleaning materials” recited in claim 7 is redrafted as -- at least two base sheets --.

6 List of Attached Document(s):

- (1) A substituted sheet of page 14 of Claims: 1

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CLAIMS:

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1. A mold cleaning material of sheet form having an upper side and a lower side and comprising at least two base sheets and a cleaning member enclosed between the two base sheets, wherein the base sheet on the upper side or the outermost layer of the upper side is a fibrous sheet having a porosity of 70% or more, and the base sheet on the lower side is at least one of a fibrous sheet having a porosity of 40% or less and a heat-resistant film.
2. The mold cleaning material according to claim 1, further comprising a molding member enclosed between the two base sheets.
3. The mold cleaning material according to claim 2, wherein the molding member is at least one of unvulcanized synthetic rubber and unvulcanized natural rubber.
4. The mold cleaning material according to claim 1, 2 or 3, which is for cleaning a mold for single-side encapsulation of a substrate.
5. The mold cleaning material according to any one of claims 1 to 4, wherein the cleaning member has at least one of a tablet form, a granular form, a powder form, a plate form, and a sheet form.
6. (Amended) The mold cleaning material according to any one of claims 1 to 5, wherein a thermoplastic resin film or tape is applied to at least a part of the surface of at least one of the base sheets, and the cleaning member or a combination of the cleaning member and the molding member is enclosed by heat sealing the at least two base sheets via the thermoplastic resin film or tape or by coating and laminating the at least two base sheets with the thermoplastic resin film or tape.
7. (Amended) The mold cleaning material according to any one of claims 1 to 5, wherein the cleaning member or a combination of the cleaning member and the molding member is enclosed by partly adhering the at least two base sheets with at least one of a double-sided tape, an adhesive, and a pressure sensitive adhesive.
8. The mold cleaning material according to any one of claims 1 to 5, wherein the cleaning member or a combination of the cleaning member and the molding member is enclosed by partly adhering the at least two base sheets by pressing or deforming the at least two base sheets.
9. A method of cleaning a mold comprising the steps of inserting the mold cleaning material according to any one of claims 1 to 8 between two halves of a heated mold, applying heat and pressure to the mold cleaning material for a predetermined time to cure the cleaning member, and removing the cleaning material from the mold.

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